RoHS

COMPLIANT

HALOGEN FREE

**GREEN** 

(5-2008)



# High Frequency 50 GHz Thin Film Chip Resistor







CH02016 (flip chip)

CH0402 (flip chip)

CH0603 (flip chip)

o) (flip chip)

**DIMENSIONS** in millimeters (inches)

### **ADDITIONAL RESOURCES**

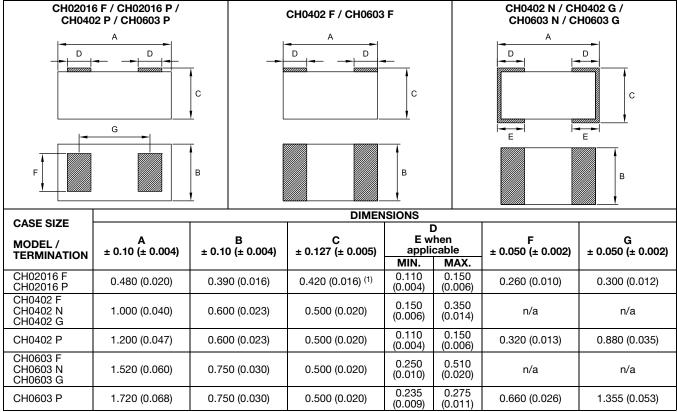


Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz.

#### **FEATURES**

- Operating frequency 50 GHz
- Thin film microwave resistors
- Flip chip, wraparound or one face termination
- Small size, down to 20 mils by 16 mils
- · Edged trimmed block resistors
- Pure alumina substrate (99.5 %)
- Ohmic range: 10R to 500R
- Design kits available
- Small internal reactance (LC down to 1 x 10<sup>-24</sup>)
- Tolerance 1 %, 2 %, 5 %
- TCR: 100 ppm/°C in (-55 °C, +155 °C) temperature range
- TCR: 50 ppm/°C available upon request for 10  $\Omega$  to150  $\Omega$  ohmic range
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

STANDARD ELECTRICAL SPECIFICATIONS						
MODEL	SIZE	$\begin{array}{c} \textbf{RESISTANCE} \\ \textbf{RANGE} \\ \Omega \end{array}$	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C
CH02016	02016	10 to 500	0.030	30	2, 5	100 (50 upon request)
CH0402	0402	10 to 500	0.050	37	1, 2, 5	100 (50 upon request)
CH0603	0603	10 to 500	0.125	50	1, 2, 5	100 (50 upon request)



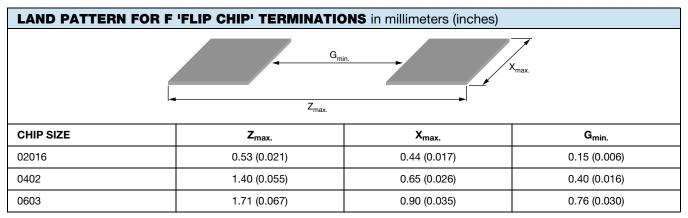
#### Note

 $^{(1)}$  ± 0.070 (± 0.003)



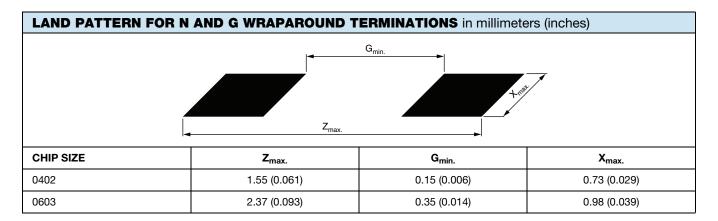
# Vishay Sfernice

TOLERANCE VS. OHMIC VALUES					
Ohmic range	10 Ω ≤ <i>R</i> < 50 Ω	$50~\Omega \le R \le 500~\Omega$			
Tolerance CH02016	5 %	2 %, 5 %			
Tolerance CH0402 and CH0603	2 %, 5 %	1 %, 2 %, 5 %			



#### Note

• Suggested land pattern: According to IPC-7351



Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard"





#### PREFERRED MODELS AND VALUES

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances.

Recommended Values:

10R/18R/25R/50R/75R/100R/150R/180R/200R/250R/330R /500R

Those values are available with a MOQ of 100 pieces.

Recommended termination:

F

Recommended tolerance:

2 %

Other values can be ordered upon request, but higher MOQ will apply: 1000 pieces for CH02016, 500 pieces for CH0402, 50 pieces for CH0603.

#### **DESIGN KITS**

Design kits are available Ex Stock in CH02016 and CH0402 sizes. There are 20 pieces per recommended value. F termination. 5 % tolerance.

Those kits are packaged in pieces of tape and delivered in ESD bags.

#### **PACKAGING**

Standard packaging is plastic tape and reel for all sizes.

Paper tape and reel is available for sizes 0402 and 0603.

Waffle pack is available for all sizes.

Depending on the type of terminations, parts will be packed differently:

#### One face:

Gold terminations: (P termination option): active face up

• Tin / silver terminations: (F termination option): active face down in tape and reel

active face up in waffle pack

#### Note

• Please refer to Vishay Sfernice Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Products" for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies

	MOQ	NUMBER OF PIECES PER PACKAGE			
SIZE		WAFFLE PACK	TAPE AND REEL		TAPE WIDTH
		2" x 2"	MIN.	MAX.	
02016	See MOQ mentioned	484	100	5000	8 mm
0402	on preferred models	100			
0603	and values	100			

### **PACKAGING RULES**

#### Waffle Pack

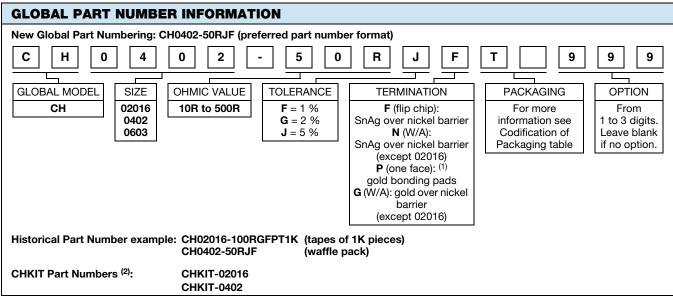
Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover. To get "not stacked up" waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

### **Tape and Reel**

See Part Numbering information to get the quantity desired by tape

In regard to the CH02016 size only, up to 5 empty cavities can be found every 1000 parts in the reel. Nevertheless, the number of requested parts will be respected.

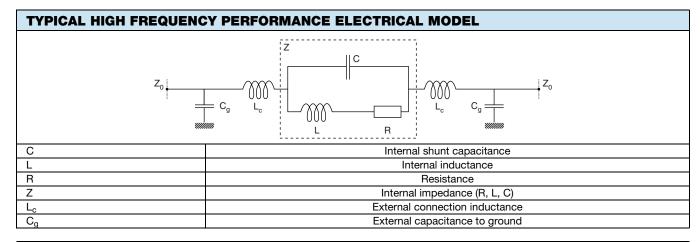




#### Notes

- Historical part numbers are not recommended but can still be used for ordering
- (1) Gold termination for application in hermetic package. Can also be mounted on PCB with SnAg solder paste
- (2) CHKIT for 0603 size is not available

CODIFICATION OF PACKAGING				
WAFFLE PACK (available for all sizes)				
W	100 min., 1 mult.			
PLASTIC TAPE (standard packaging for all sizes)				
Т	100 min., 1 mult.			
TA	100 min., 100 mult.			
TB	250 min., 250 mult.			
TC	500 min., 500 mult.			
TD	1000 min., 1000 mult.			
TE	2500 min., 2500 mult.			
TF	Full tape (quantity depending on size of chips)			
PAPER TAPE (available for 0402 a	nd 0603)			
PT	100 min., 1 mult.			
PA	100 min., 100 mult.			
PB	250 min., 250 mult.			
PC	500 min., 500 mult.			
PD (not available for size 0402)	1000 min., 1000 mult.			
PE (not available for size 0402)	2500 min., 2500 mult.			
PF (not available for size 0402)	Full tape (quantity depending on size of chips)			



Revision: 21-Jan-2020 4 Document Number: 53014



# Vishay Sfernice

The complex impedance of the chip resistor is given by the following equations:

$$Z = \frac{R + j\omega(L - R^{2}C - L^{2}C\omega^{2})}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]}$$

$$\frac{[Z]}{R} = \frac{1}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]} \times \sqrt{1 + \left[\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}\right]^{2}}$$

$$\theta = \tan^{-1}\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}$$

#### Notes

- $\omega = 2 \times \pi \times f$
- f: frequency

R, L and C are relevant to the chip resistor itself.

 $L_c$  and  $C_q$  also depend on the way the chip resistor is mounted.

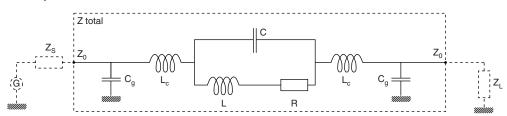
It is important to notice that after assembly the external reactance of  $L_c$  and  $C_g$  will be combined to internal reactance of L and C. This combination can upgrade or downgrade the HF behavior of the component.

This is why we are displaying three sets of data:

- $\frac{[Z]}{R}$  versus frequency curves which aim to show at a glance the intrinsic HF performance of a given chip resistor
- $\frac{[Z_{\text{total}}]}{R}$  versus frequency curves which aim to show the behavior of the chip resistor when mounted

These lines are terminated with adapted source and load impedance respectively  $Z_s$  and  $Z_l$  with  $Z_0 = Z_L = Z_s$  (for others configurations please consult us).

Equivalent circuit for S-parameters:

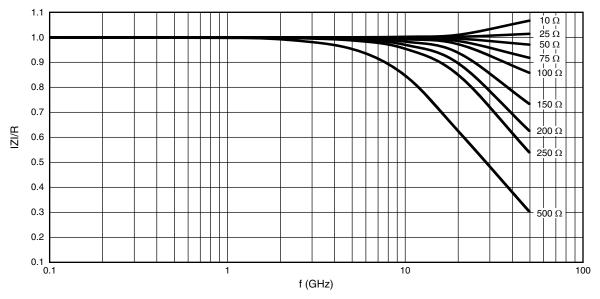


S-parameters are computed taking into account all the resistive, inductive and capacitive elements (Z total) and  $Z_0 = Z_L = Z_s = R$ .

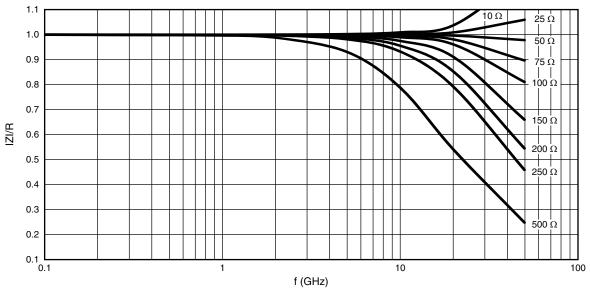
For simulation purposes, those S-parameter data are available for download here: <a href="www.vishay.com/doc?53061">www.vishay.com/doc?53061</a>



## **INTERNAL IMPEDANCE CURVES**

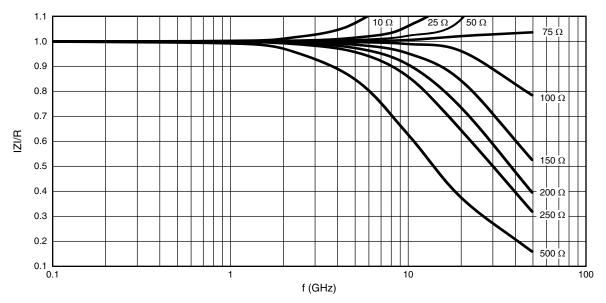


Internal impedance curve for 02016 size (F and P terminations)

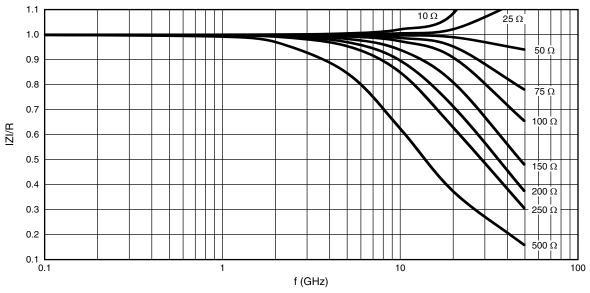


Internal impedance curve for 0402 size (F and P terminations)

## **INTERNAL IMPEDANCE CURVES**

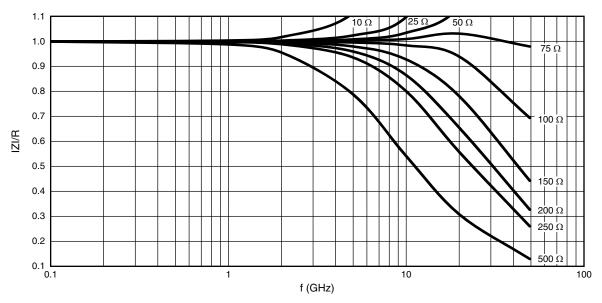


Internal impedance curve for 0402 size (N and G terminations)



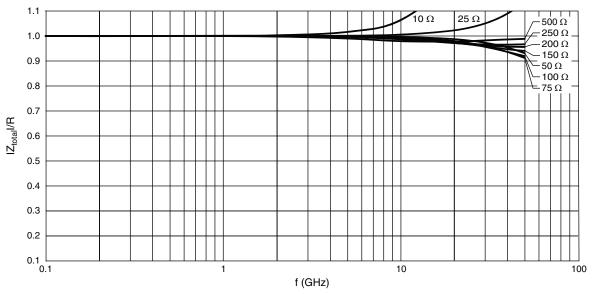
Internal impedance curve for 0603 size (F and P terminations)

## **INTERNAL IMPEDANCE CURVES**



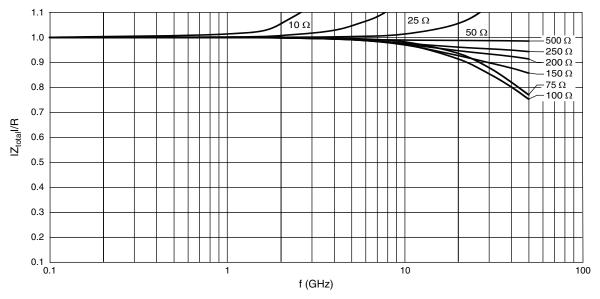
#### Internal impedance curve for 0603 size (N and G terminations)

## INTERNAL IMPEDANCE CURVES ( $|Z_{TOTAL}| / R$ )

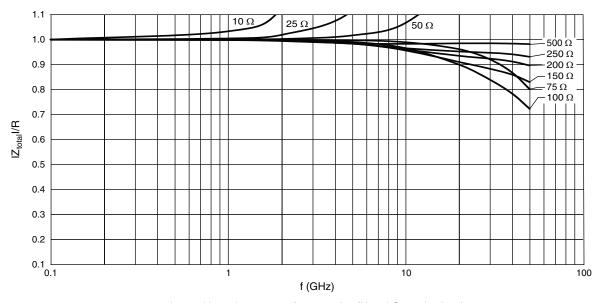


Internal impedance curve for 02016 size (F and P terminations)

## INTERNAL IMPEDANCE CURVES (|Z<sub>TOTAL</sub>| / R)

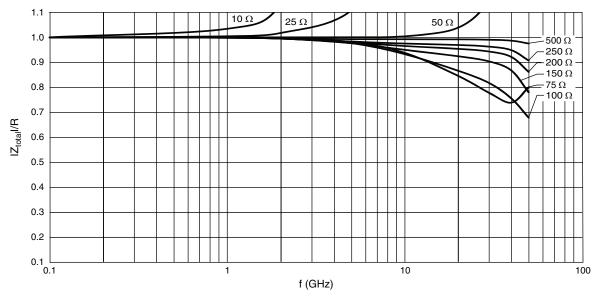


Internal impedance curve for 0402 size (F and P terminations)

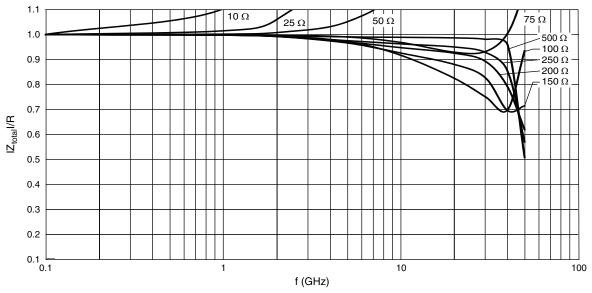


Internal impedance curve for 0402 size (N and G terminations)

## INTERNAL IMPEDANCE CURVES (|Z<sub>TOTAL</sub>| / R)



Internal impedance curve for 0603 size (F and P terminations)

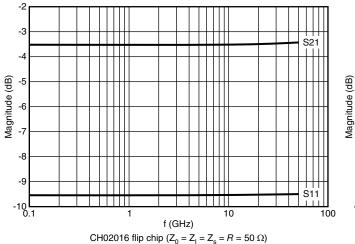


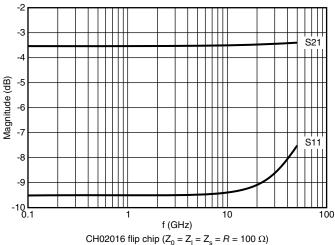
Internal impedance curve for 0603 size (N and G terminations)



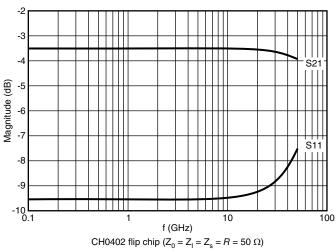
## **S-PARAMETER**

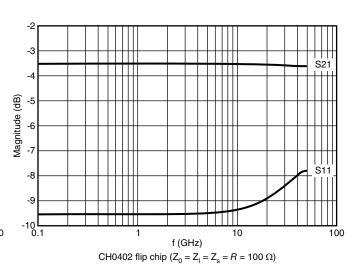
## CH02016 (F and P Terminations)



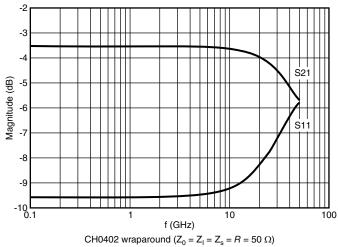


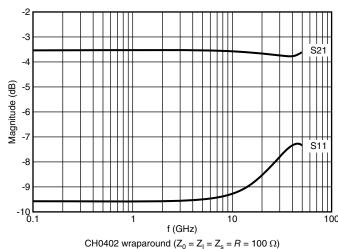
## CH0402 (F and P Terminations)





## CH0402 (N and G Terminations)

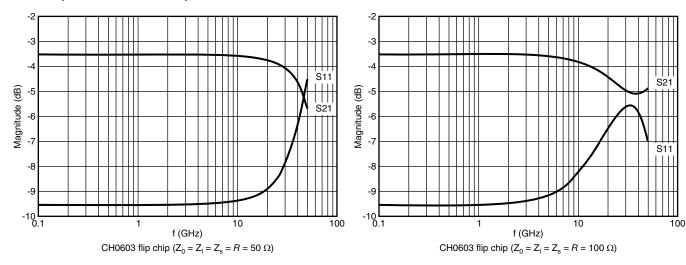




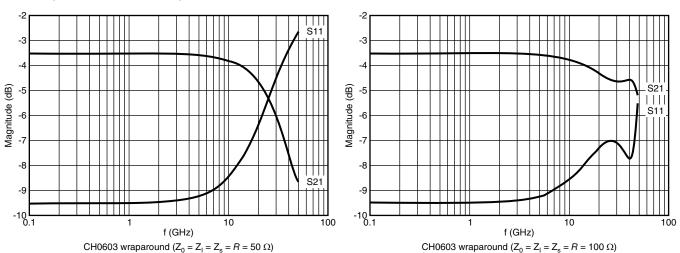
Revision: 21-Jan-2020 11 Document Number: 53014

## **S-PARAMETER**

## CH0603 (F and P Terminations)



## CH0603 (N and G Terminations)





# **Legal Disclaimer Notice**

Vishay

# **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Frequency/RF Resistors category:

Click to view products by Vishay manufacturer:

Other Similar products are found below:

800-50T-S 10-100RV-S E250N50X4 250-100RM-S 150-100RL-S A4B50X1A 10-50TV G150N50W4B 250-50TC C20A50Z4

FC1206E8450FGW0 R1A06031000G5AR 060120A25X50-2 A5B50X1A CH02016-150RGFTA CH02016-75RGFTA CH02016-100RGFTA

CH0402-100RGFTA 100200-4Z50-2 C150N50Z4 30-100R 60-50TP-S 100N50TW E200N50X4 250375-4Z50-2 60-50TPR

MIC1000AFLMGNHWS FT10301N0050J CS12010T0100GTR C8A50Z4B CS12010T0050JBK CW12010T0100GTR FR10515N0050JBK

FR10515N0100JBK FT10517N0050JBK FT10800N0050J02 LT11020T0050JBK LT12010T0050JBK 30-100R-S 400-50T 40-50TPP 60-50TP C10A50Z4 C16A50Z4 C1A50Z4 C50A50Z4 G250N50W4 G450N50W4 J100N50X4B K100N50X4B